

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Timing-Safe[™] Peak EMI Reduction IC

Functional Description

P3PS850BH is a versatile, Timing–Safe peak EMI reduction IC. P3PS850BH accepts one input from an external reference, and locks on to it delivering a 1x Timing–Safe output clock. P3PS850BH has a Frequency Selection (FS) control that facilitates selecting one of the two operating frequency ranges. Refer to the *frequency Selection table*. The device has an SSEXTR pin to select different deviations depending upon the value of an external resistor connected at this pin to GND. P3PS850BH has an MR pin for selecting one of the two Modulation Rates. PD#/OE provides the Power Down option. Outputs will be tri–stated when power down is active.

P3PS850BH operates over a supply voltage range of 2.3 V to 3.6 V, and is available in an 8 Pin WDFN (2 mm x 2 mm) Package.

General Features

- 1x, LVCMOS Timing-Safe Peak EMI Reduction
- Input Clock Frequency:
 - ◆ 18 MHz 72 MHz
- Output Clock Frequency(Timing-Safe):
 - ◆ 18 MHz 72 MHz
- Analog Frequency Deviation Selection
- Two different Modulation Rate Selection
- Power Down Option for Power Save
- Output Buffer Strength: 16 mA
- Supply Voltage: 2.3 V 3.6 V
- 8 pin WDFN 2 mm x 2 mm, (TDFN) Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Application

• P3PS850BH is targeted for use in consumer electronic applications like mobile phones, Camera modules, MFP and DPF.



ON Semiconductor®

http://onsemi.com



WDFN8 CASE 511AQ

MARKING DIAGRAMS

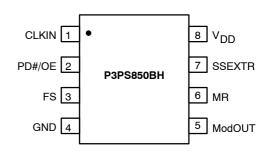


DG = Specific Device Code

M = Date Code

= Pb-Free Device

PIN CONFIGURATION



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

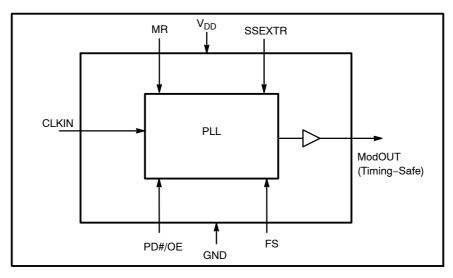


Figure 1. Block Diagram

Table 1. PIN DESCRIPTION

Pin#	Pin Name	Туре	Description
1	CLKIN	I	External reference Clock input.
2	PD# / OE	I	Power Down. Pull LOW to enable Power Down. Outputs will be tri-stated when power down is enabled. Pull HIGH to disable power down and enable output. NO default state.
3	FS	I	Frequency Select .NO default state. Refer to the Frequency Selection table
4	GND	Р	Ground
5	ModOUT	0	Buffered modulated Timing-Safe clock output
6	MR	I	Modulation Rate Select. When LOW, selects Low Modulation Rate. Selects High Modulation Rate when pulled HIGH. Has an internal pull-up resistor.
7	SSEXTR	ı	Analog Deviation Selection through external resistor to GND.
8	V_{DD}	Р	Supply Voltage

Table 2. FREQUENCY SELECTION TABLE

FS	Frequency (MHz)		
0	18–36		
1	36–72		

Table 3. OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V_{DD}	Supply Voltage	2.3	3.6	V
T _A	Operating Temperature	-20	+85	°C
CL	Load Capacitance		15	pF
C _{IN}	Input Capacitance		7	pF

Table 4. ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Rating	Unit
$V_{DD,}V_{IN}$	Voltage on any input pin with respect to Ground	-0.5 to +4.6	V
T _{STG}	Storage temperature	-65 to +125	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22-A114-B)	2	kV

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 5. DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V_{DD}	Supply Voltage			2.3	2.7	3.6	V
V _{IH}	Input HIGH Voltage			0.65 * V _{DD}			V
V_{IL}	Input LOW Voltage					0.35 * V _{DD}	V
I _{IH}	Input HIGH Current	$V_{IN} = V_{DD}$				10	μΑ
I _{IL}	Input LOW Current	V _{IN} = 0 V for MR pi	n			10	μΑ
V _{OH}	Output HIGH Voltage	I _{OH} = -16 mA		0.75 * V _{DD}			V
V_{OL}	Output LOW Voltage	I _{OL} = 16 mA	I _{OL} = 16 mA			0.25 * V _{DD}	V
I _{CC}	Static Supply Current	PD#/OE pin pulled	PD#/OE pin pulled to GND			10	μΑ
I_{DD}	Dynamic Supply Current	Unloaded Output	FS = 0, @ 18 MHz		6	10	mA
			FS = 0, @ 24 MHz		7	12	
			FS = 0, @ 36 MHz		10	17	
			FS = 1, @ 36 MHz		9	14	
			FS = 1, @ 48 MHz		11	19	
			FS = 1, @ 72 MHz		16	28	
Z _o	Output Impedance		•		13		Ω

Table 6. AC ELECTRICAL CHARACTERISTICS

Parameter	Test Conditions	Min	Тур	Max	Unit
Input Frequency	FS = 0	18	24	36	MHz
	FS = 1	36	48	72	
ModOUT	FS = 0	18	24	36	1
	FS = 1	36	48	72	1
Duty Cycle (Note 1 and 2)	Measured at V _{DD} / 2	45	50	55	%
Rise Time (Note 1 and 2)	Measured between 20% to 80%		0.8	1.2	ns
Fall Time (Note 1 and 2)	Measured between 80% to 20%		0.8	1.2	ns

^{1.} All parameters are specified with 15 pF loaded output.

^{2.} Parameter is guaranteed by design and characterization. Not 100% tested in production.

Table 6. AC ELECTRICAL CHARACTERISTICS

Parameter	Test C	Test Conditions		Тур	Max	Unit
Cycle-to-Cycle Jitter (Note 2)	with SSEXTR pin OPEN	FS = 0, 18 MHz		± 250	±350	ps
		FS = 0, 24 MHz		± 150	±225	
		FS = 0, 36 MHz		± 75	± 125	
		FS = 1, 36 MHz		± 150	±200	
		FS = 1, 48 MHz		±100	± 150	
		FS = 1, 72 MHz		± 75	± 125	
PLL Lock Time (Note 2)		Stable power supply, valid clock presented on CLKIN pin, PD# toggled from Low to High			1	ms

All parameters are specified with 15 pF loaded output.
 Parameter is guaranteed by design and characterization. Not 100% tested in production.

DEVIATION VERSUS SSEXTR RESISTANCE CHARTS

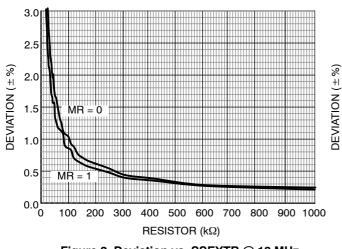


Figure 2. Deviation vs. SSEXTR @ 18 MHz (FS = 0)

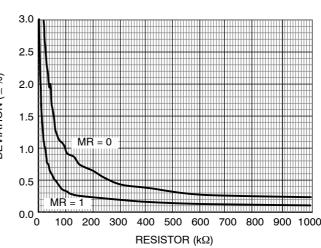


Figure 3. Deviation vs. SSEXTR @ 24 MHz (FS = 0)

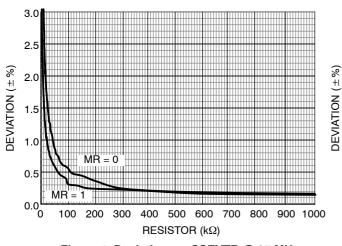


Figure 4. Deviation vs. SSEXTR @ 27 MHz (FS = 0)

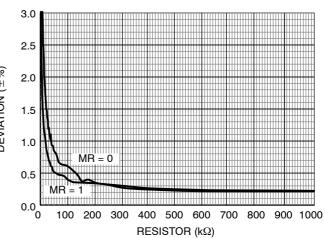


Figure 5. Deviation vs. SSEXTR @ 30 MHz (FS = 0)

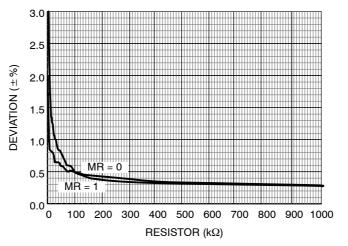
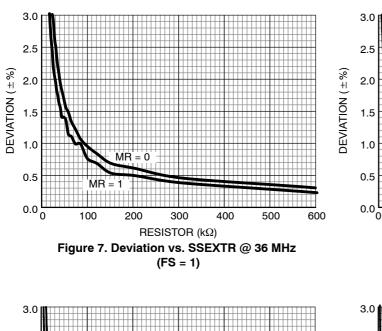


Figure 6. Deviation vs. SSEXTR @ 36 MHz (FS = 0)

DEVIATION VERSUS SSEXTR RESISTANCE CHARTS



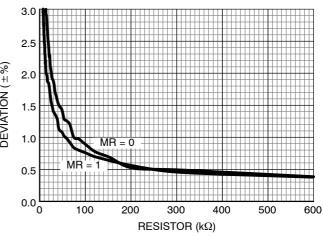
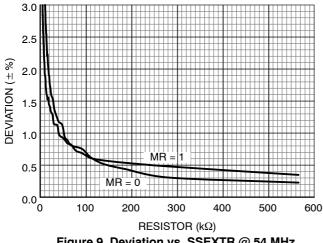


Figure 8. Deviation vs. SSEXTR @ 48 MHz (FS = 1)



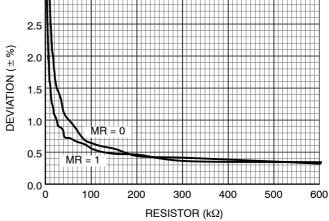


Figure 9. Deviation vs. SSEXTR @ 54 MHz (FS = 1)

Figure 10. Deviation vs. SSEXTR @ 60 MHz (FS = 1)

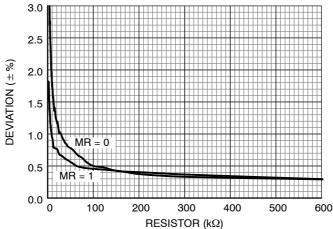


Figure 11. Deviation vs. SSEXTR @ 72 MHz (FS = 1)

TSKEW VERSUS SSEXTR RESISTANCE CHARTS

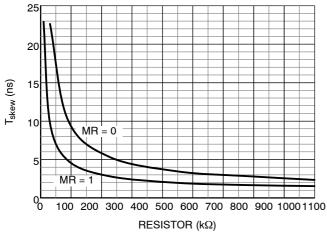


Figure 12. Tskew vs. SSEXTR @ 18 MHz (FS = 0)

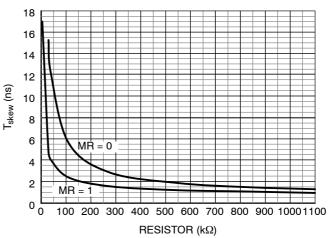


Figure 13. Tskew vs. SSEXTR @ 24 MHz (FS = 0)

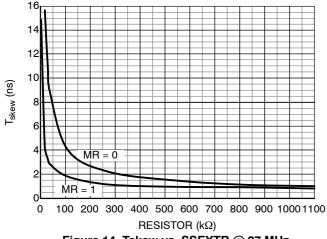


Figure 14. Tskew vs. SSEXTR @ 27 MHz (FS = 0)

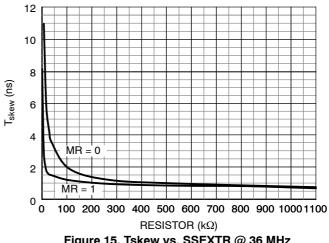


Figure 15. Tskew vs. SSEXTR @ 36 MHz (FS = 0)

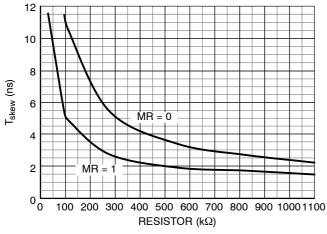


Figure 16. Tskew vs. SSEXTR @ 36 MHz (FS = 1)

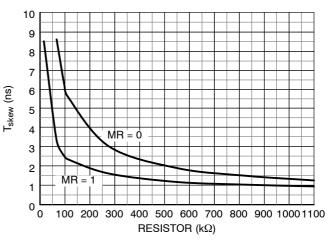


Figure 17. Tskew vs. SSEXTR @ 48 MHz (FS = 1)

TSKEW VERSUS SSEXTR RESISTANCE CHARTS

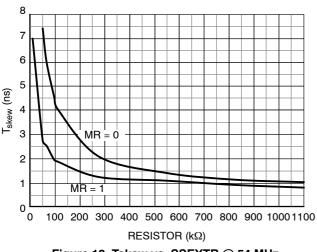


Figure 18. Tskew vs. SSEXTR @ 54 MHz (FS = 1)

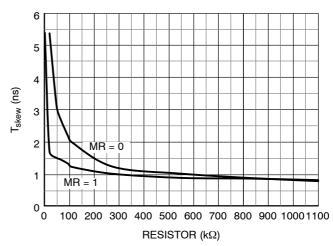


Figure 19. Tskew vs. SSEXTR @ 72 MHz (FS = 1)

MINIMUM SSEXTR RESISTANCE VERSUS FREQUENCY(FOR TIMING-SAFE OPERATION) CHARTS

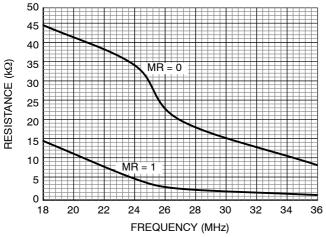


Figure 20. Frequency vs. Resistance (FS = 0)

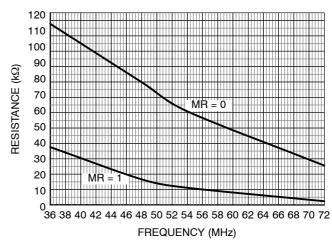


Figure 21. Frequency vs. Resistance (FS = 1)

NOTE: Device-to-Device variation of Deviation and Tskew is $\pm\,10\%$

SWITCHING WAVEFORMS

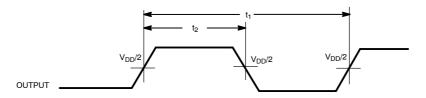


Figure 22. Duty Cycle Timing

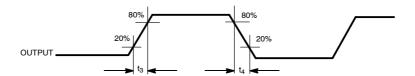
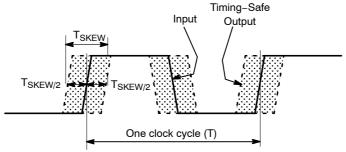
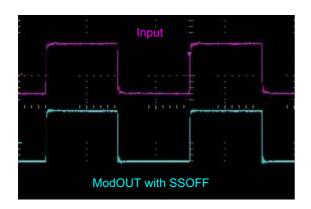


Figure 23. Output Rise/Fall Time



T_{SKEW} represents input-output skew when spread spectrum is ON For example, T_{SKEW} / 2 = 0.20 * T for an Input clock of 24 MHz, translates in to (1/24 MHz) * 0.20 = 8.33 ns

Figure 24. Input-Output Skew



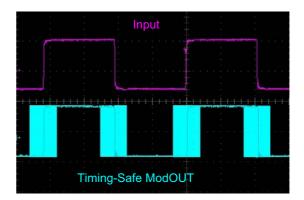
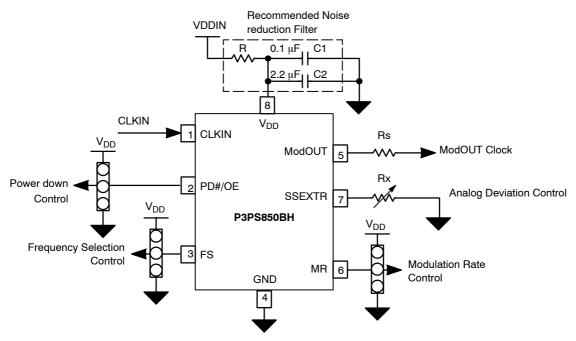


Figure 25. Typical Example of Timing-Safe Waveform



NOTE: Refer Pin Description table for Functionality details.

Figure 26. Typical Application Schematic

PCB Layout Recommendation

For optimum device performance, following guidelines are recommended.

- Dedicated V_{DD} and GND planes.
- The device must be isolated from system power supply noise. A 0.1 μF and a 2.2 μF decoupling capacitor should be
 mounted on the component side of the board as close to the V_{DD} pin as possible. No vias should be used between the
 decoupling capacitor and V_{DD} pin. The PCB trace to V_{DD} pin and the ground via should be kept as short as possible.
 All the V_{DD} pins should have decoupling capacitors.
- In an optimum layout all components are on the same side of the board, minimizing vias through other signal layers. A typical layout is shown in Figure 27.

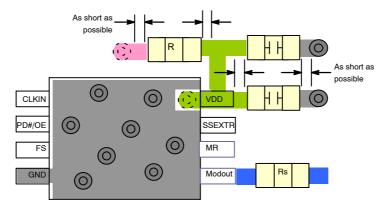


Figure 27.

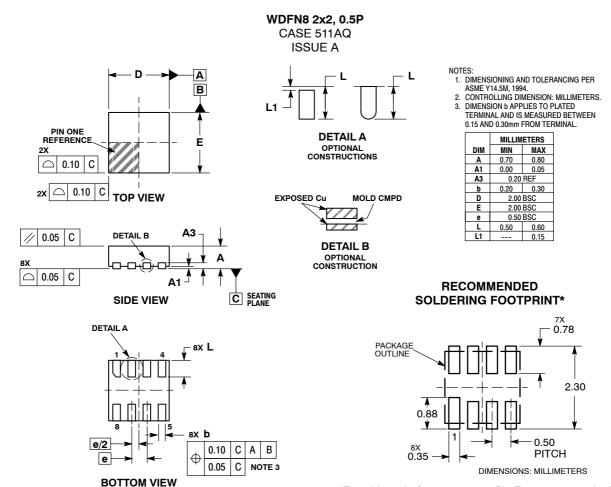
ORDERING INFORMATION

Part Number	Top Marking	Temperature	Package Type	Shipping [†]
P3PS850BHG-08CR	DG	-20°C to +85°C	8-Pin (2 mm x 2 mm) WDFN(TDFN) (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-Free.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Timing-Safe is a trademark of Semiconductor Components Industries, LLC (SCILLC).

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative